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IGBT - Field Stop, Trench

1200 V, 40 A

FGH40T120SMD, FGH40T120SMD-F155

Description

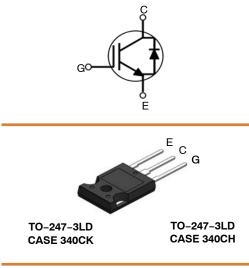
Using innovative field stop trench IGBT technology, **onsemi**'s new series of field stop trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder and PFC applications.

Features

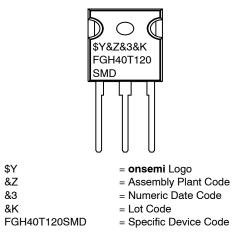
- FS Trench Technology, Positive Temperature Coefficient
- High Speed Switching
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V} @ \text{ I}_{C} = 40 \text{ A}$
- 100% of the Parts Tested for $I_{LM}(1)$
- High Input Impedance
- These Devices are Pb-Free and are RoHS Compliant

Applications

• Solar Inverter, Welder, UPS & PFC Applications



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Descrip	Symbol	Ratings	Unit	
Collector to Emitter Voltage		V _{CES}	1200	V
Gate to Emitter Voltage	V _{GES}	±25	V	
Transient Gate to Emitter Voltage	1	±30	V	
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι _C	80	А
Collector Current	$T_{\rm C} = 100^{\circ}{\rm C}$	7 F	40	А
Clamped Inductive Load Current	$T_{\rm C} = 25^{\circ}{\rm C}$	I _{LM} (Note 1)	160	А
Pulsed Collector Current	I _{CM} (Note 2)	160	А	
Diode Continuous Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	۱ _F	80	А
Diode Continuous Forward Current	$T_{\rm C} = 100^{\circ}{\rm C}$	1 F	40	А
Diode Maximum Forward Current		I _{FM}	240	А
Maximum Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	PD	555	W
Maximum Power Dissipation	$T_{\rm C} = 100^{\circ}{\rm C}$	1 F	277	W
Operating Junction Temperature		TJ	–55 to +175	°C
Storage Temperature Range	T _{stg}	-55 to +175	°C	
Maximum Lead Temp. for soldering Purpo	TL	300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Vcc = 600 V,V_{GE} = 15 V, I_C = 160 A, R_G = 10 Ω , Inductive Load 2. Limited by Tjmax

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (IGBT)	_	0.27	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (Diode)	-	0.89	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGH40T120SMD	FGH40T120SMD	TO-247-3 (PB-Free)	-	-	30
FGH40T120SMD	FGH40T120SMD-F155	TO-247-3 (Pb-Free)	-	-	30

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 250 µA	1200	-	-	V
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs						
G-E Threshold Voltage	V _{GE(th)}	$I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.9	6.2	7.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 25°C	-	1.8	2.4	V
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 175°C	-	2.0	-	V

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS				•		
Input Capacitance	C _{ies}	$V_{CE} = 30 \text{ V}, \text{ V}_{GE} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	4300	-	pF
Output Capacitance	C _{oes}		-	180	-	pF
Reverse Transfer Capacitance	C _{res}	1	-	100	-	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	40	-	ns
Rise Time	t _r	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25$ °C	-	47	-	ns
Turn-Off Delay Time	t _{d(off)}		-	475	-	ns
Fall Time	t _f		-	10	-	ns
Turn-On Switching Loss	E _{on}		-	2.7	-	mJ
Turn-Off Switching Loss	E _{off}		-	1.1	-	mJ
Total Switching Loss	E _{ts}		-	3.8	-	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ Inductive Load, $T_{C} = 175^{\circ}\text{C}$	-	40	-	ns
Rise Time	tr		-	55	-	ns
Turn-Off Delay Time	t _{d(off)}		_	520	-	ns
Fall Time	t _f		-	50	-	ns
Turn-On Switching Loss	E _{on}	-	-	3.4	-	mJ
Turn-Off Switching Loss	E _{off}		-	2.5	-	mJ
Total Switching Loss	E _{ts}		-	5.9	-	mJ
Total Gate Charge	Qg	V_{CE} = 600 V, I_{C} = 40 A, V_{GE} = 15 V	-	370	-	nC
Gate to Emitter Charge	Q _{ge}	-	-	23	-	nC
Gate to Collector Charge	Q _{gc}		_	210	_	nC

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25°C unless otherwise noted)

Parametr	Symbol	Test Conditions	Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	$I_F = 40 \text{ A}, \text{ T}_C = 25^{\circ}\text{C}$	-	3.8	4.8	V
		I _F = 40 A, T _C = 175°C	-	2.7	-	V
Diode Reverse Recovery Time	t _{rr}	V _R = 600 V, I _F = 40 A, di _F /dt = 200 A/µs, T _C = 25°C	-	65	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	7.2	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	234	-	nC
Diode Reverse Recovery Time	t _{rr}	V _R = 600 V, I _F = 40 A, di _F /dt = 200 A/μs, T _C = 175°C	-	200	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	18.0	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	1800	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

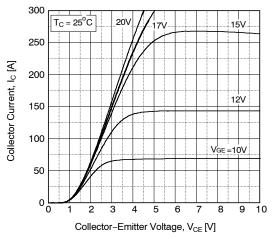


Figure 1. Typical Output Characteristics

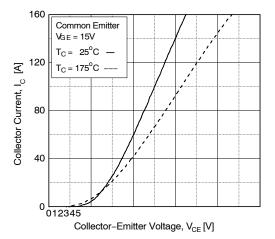


Figure 3. Typical Saturation Voltage Characteristics

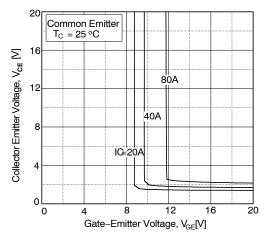


Figure 5. Saturation Voltage vs V_{GE}

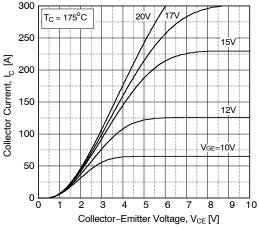


Figure 2. Typical Output Characteristics

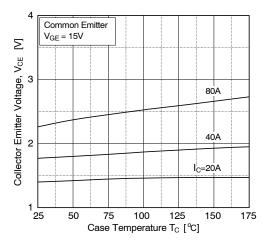


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

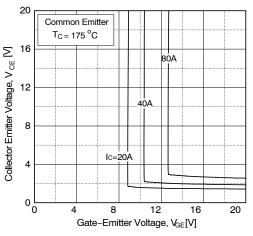


Figure 6. Saturation Voltage vs VGE

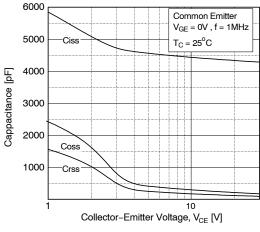


Figure 7. Capacitance Characteristics

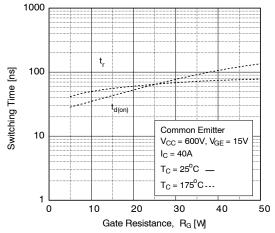


Figure 9. Turn-On Characteristics vs. Gate Resistance

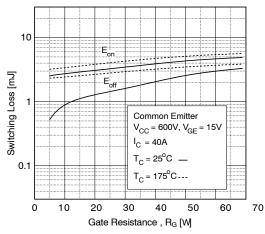
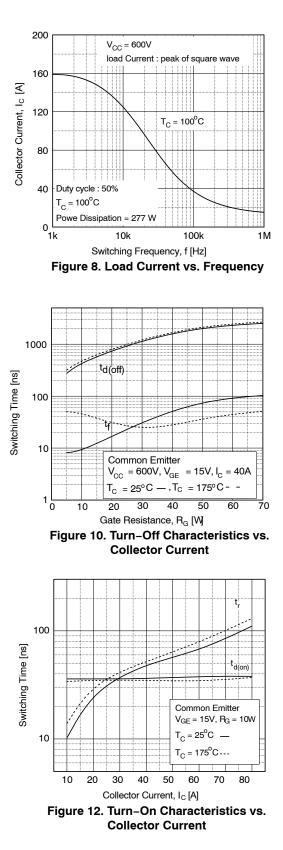
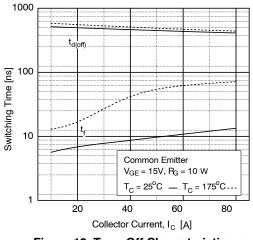
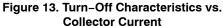


Figure 11. Switching Loss vs. Gate Resistance







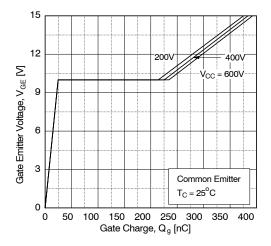


Figure 15. Gate Charge Characteristics

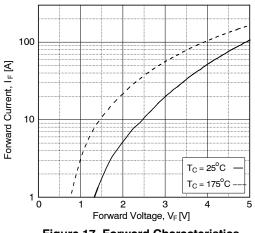


Figure 17. Forward Characteristics

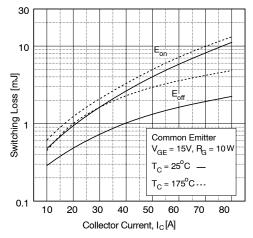


Figure 14. Switching Loss vs. Collector Current

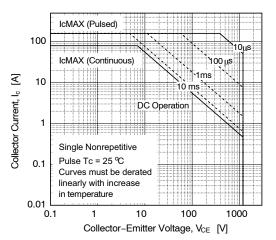


Figure 16. SOA Characteristics

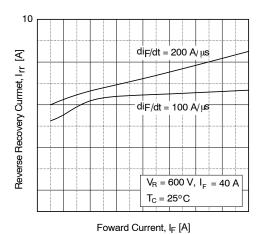
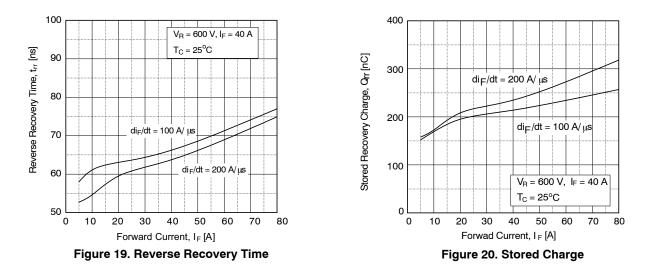


Figure 18. Reverse Recovery Current



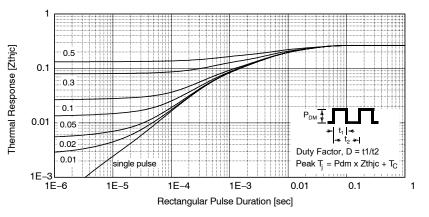
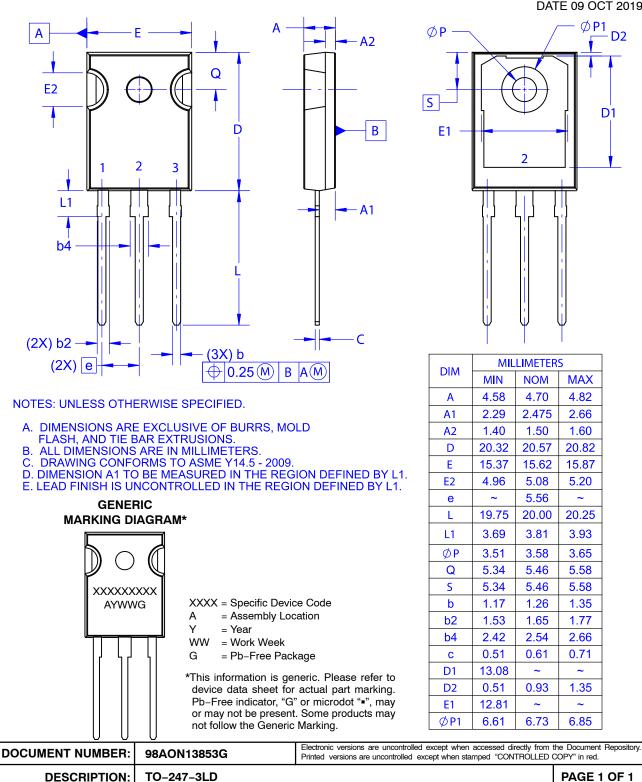


Figure 21. Transient Thermal Impedance of IGBT



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DATE 09 OCT 2019

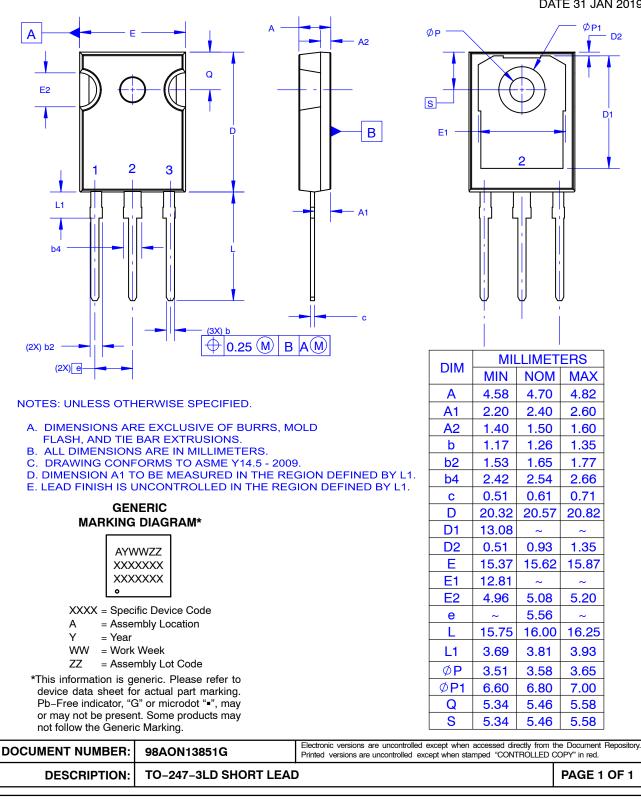


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